

# The Big Deal

- Patented design eliminates in band spurs
- Pass band cut-off up to 21 GHz
- Stop band up to 35 GHz
- Excellent repeatability through IPD\* process



Available in Low Pass, High Pass and Band Pass designs

# **Product Overview**

Mini-Circuits' *X-Series* reflectionless filters employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level which interact with neighboring components and often result in intermodulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

Key Features	Advantages
Easy integration with sensitive reflective components, e.g. mixers, multipliers	Reflectionless filters absorb unwanted signals, preventing reflections back to the source. This reduces generation of additional unwanted signals without the need for extra components like attenuators, improving system dynamic range and saving board space.
Enables stable integration of wideband amplifiers	Because reflectionless filters maintain good impedance in the stop band; they can be integrated with high gain, wideband amplifiers without the risk of creating instabilities in these out of band regions.
Cascadable	Reflectionless filters can be cascaded in multiple sections to provide sharper and higher attenuation, while also preventing any standing waves that could affect pass band signals.
Excellent power handling in a tiny surface mount device	High power handling extends the usability of these filters to the transmit path for inter-stage filtering.
Small size, 3x3mm QFN	Allows replacement of filter/attenuator pairs with a single reflectionless filter, sav- ing board space.
Excellent repeatability of RF performance	Through semiconductor IPD process, X-series filters are inherently repeatable for large volume production.
Excellent stability over temperature	With $\pm 0.3$ dB variation over temperature ideal for use in wide temperature range applications without the need for additional temperature compensation.
Operating temperature up to 105°C	Suitable for operation close to high power components.

\*IPD - Integrated Passive Device, is a GaAs semiconductor process

# Reflectionless Low Pass Filter

# 50Ω DC to 550 MHz

#### Features

- $\bullet$  Match to 50  $\!\Omega$  in the stop band, eliminates undesired reflections
- Cascadable
- Excellent Power handling
- Temperature stable, up to 105°C
- Small size, 3 x 3 mm
- Protected by US Patent No. 8,392,495

#### Applications

- Harmonics Rejection
- Wideband Matching
- Transmitters / Receivers

### **General Description**



Generic photo used for illustration purposes only CASE STYLE: DQ1225

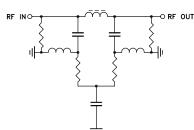
**XLF-551+** 

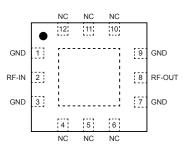
+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost					
Reel Size	Devices/Reel				
7"	20, 50, 100, 200, 500, 1000, 2000				

Mini-Circuits' XLF-551+ reflectionless filter employs a novel filter topology which absorbs and terminates stop band signals internally rather than reflecting them back to the source. This new capability enables unique applications for filter circuits beyond those suited to traditional approaches. Traditional filters are reflective in the stop band, sending signals back to the source at 100% of the power level. These reflections interact with neighboring components and often result in inter-modulation and other interferences. Reflectionless filters eliminate stop band reflections, allowing them to be paired with sensitive devices and used in applications that otherwise require circuits such as isolation amplifiers or attenuators.

#### simplified schematic and pad description





Function	Pad Number	Description
RF-IN	2	RF Input Pad
RF-OUT	8	RF Output Pad
GND	1,3,7,9, Paddle	Connected to ground
NC (GND Externally)	4,5,6,10,11,12	No internal connection

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#### Electrical Specifications<sup>1</sup> at 25°C

Parameter		F#	Frequency (MHz)	Min.	Тур.	Max.	Unit
Pass Band	Insertion Loss Frequency Cut-off	DC - F1 F2	DC - 550 770	_	1.4 3.0	1.8 —	dB dB
	VSWR	DC - F1	DC - 550	_	1.2	_	:1
	Dejection	F3 - F4	1140 - 5800	12	15	—	dB
Stop Band	Rejection	F4 - F5	5800 - 18500	—	24	_	dB
etep Dana	VSWR	F3 - F4	1140 - 5800	—	1.2	—	:1
		F4 - F5	5800 -18500	—	1.6	—	:1

<sup>1</sup> Measured on Mini-Circuits Characterization Test Board TB-844-551+

# Absolute Maximum Ratings<sup>4</sup>

Parameter	Ratings
Operating Temperature	-55°C to +105°C
Storage Temperature	-65°C to +150°C
RF Power Input, Passband (DC-F1) <sup>2</sup>	2W at 25°C
RF Power Input, Stopband (F2-F5) <sup>3</sup>	0.2W at 25°C

 $^{\scriptscriptstyle 2}$  Passband rating derates linearly to 1W at 105°C ambient

Stopband rating derates linearly to 0.1W at 105°C ambient
 Permanent damage may occur if any of these limits are exceeded.

#### **ESD** rating

Human body model (HBM): Class 1A (250 to <500V) in accordance with ANSI/ESD 5.1-2001

#### MSL rating

Moisture Sensitivity: MSL1 in accordance with IPC/JEDEC J-STD-020D

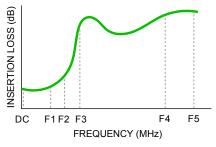
#### Frequency (MHz) Insertion Loss VSWR (dB) (:1) 10 0.81 1.09 50 100 0.76 0.76 1.06 1.07 200 0.80 1.11 550 770 1140 1.34 1.22 3.06 15.12 1.18 1.15 2000 14.94 1.07 3000 4500 15.33 17.13 1.09 1.15 5800 1.34 15.30 7000 17.36 1.21 8500 10000 29.21 29.02 1.16 1.24 11500 27.30 1.51 13000 25.73 1.69 24.32 14500 1.74 1.69 16000 23.07 17500 22.26 1.96 18500 22.74 2.96 XLF-551+ VSWR XLF-551+ INSERTION LOSS 40 3.0 INSERTION LOSS (dB) 2.5 30 VSWR 2.0 20 10 1.5 1.0 0 3700 7400 14800 18500 0 3700 7400 11100 14800 18500 0 11100 FREQUENCY (MHz) FREQUENCY (MHz)

# Typical Performance Data at 25°C

# lMini-Circuits

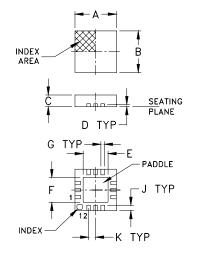
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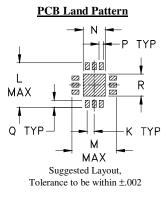
#### Specification Definition



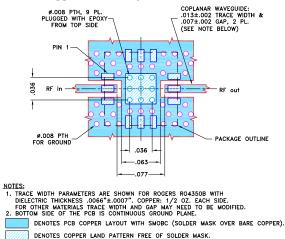
# XLF-551+

# **Outline Drawing**





Demo Board MCL P/N: TB-844-551+ (without connectors) TB-844-551C+ (with connectors) B20-118-F1+ Connector sold separately Suggested PCB Layout: PL-451+



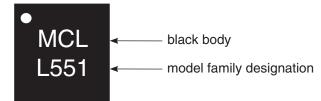
## Outline Dimensions ( inch )

Α	В	С	D	E	F	G	н	J
.118	.118	.035	.008	.057	.057	.009		.016
3.00	3.00	0.89	0.20	1.45	1.45	0.23		0.41
К	L	М	Ν	Р	Q	R		wt
.020	.127	.127	.049	.010	.020	.049	9	grams
0.51	3.23	3 33	1 24	0.25	0.51	1 2/		0.02

## **Tape & Reel Packaging**

DEVICE ORIENTATION IN T&R

# **Product Marking**



DIRECTION	OF	FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20 50 100 200 500
		7	Standard	1000, 2000